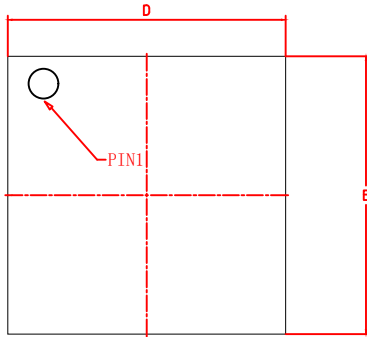


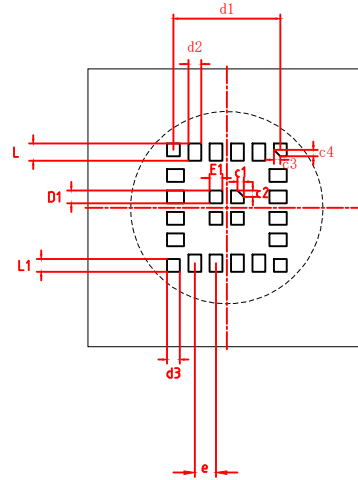
TOP VIEW  
正视图



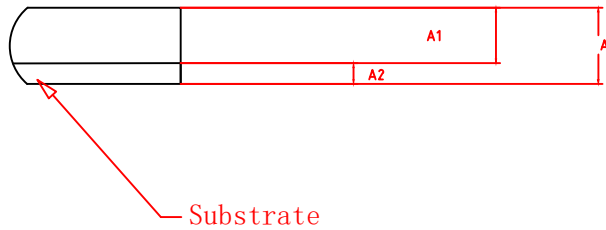
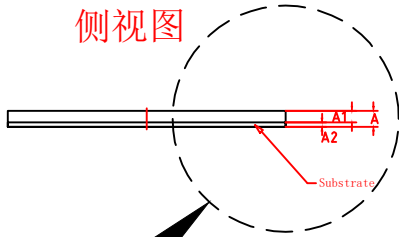
SIDE VIEW  
侧视图




BOTTOM VIEW  
背视图



SIDE VIEW  
侧视图



机械尺寸/mm			
字符 SYMBOL	最小值 MIN	典型值 NOMINAL	最大值 MAX
D	12.900	13.000	13.100
E	12.900	13.000	13.100
A	0.620	0.650	0.680
A1	0.427	0.447	0.467
A2	0.193	0.203	0.213
c1	0.250	0.300	0.350
c2	0.250	0.300	0.350
c3	0.250	0.300	0.350
c4	0.250	0.300	0.350
d1	5.000 BSC		
d2	0.5900	0.600	0.610
d3	0.5900	0.600	0.610
e	1.00 BSC		
L	0.700	0.800	0.900
L1	0.500	0.600	0.700
D1	0.500	0.600	0.700
E1	0.500	0.600	0.700

 <b>池州华宇电子科技股份有限公司</b> CHI ZHOU HISEMI ELECTRONICS TECHNOLOGY CO.,LTD		制图: Draw	NINGLIN 2024. 5. 23
图号 Drawing NO.	HY-POD-LGA0017		制图核查: Drawing review
Title 产品外形图	PACKAGE OUTLINE DIMENSIONS LGA24L (13.0×13.0×0.65-P1.00)		审核: Checker
幅图 size	页数 page	单位 unit	比例 scale
A4	1	mm	1:1
			视图 view
			核准: Approved